| © Copyright 2005. IPC                           | © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions. |                           |                          |              | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |                     |                  |                         |                    |                                 |                  |                  |           |  |
|---|--|---------------------------|--------------------------|--------------|---|---------------------|------------------|-------------------------|--------------------|---------------------------------|------------------|------------------|-----------|--|
|   | IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distribute                               |                           |                          |              | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi  |                     |                  |                         |                    | als and Mfg Information         |                  |                  |           |  |
| Supplier Information                            |  |                           |                          |              |   |                     |                  |                         |                    |                                 |                  |                  |           |  |
| Company name* Compar                            |  |                           | ompany unique ID         |              |   | Unique ID Authority |                  |                         |                    | Response Date*                  |                  |                  |           |  |
| onsemi  |  |                           |                          |              |   |                     |                  |                         |                    |                                 | 2024-04-17       |                  |           |  |
| Contact Name Title - Contact                    |  |                           | ct                       | PI           |   |                     | Phone - Contact* |                         |                    |                                 | Email - Contact* |                  |           |  |
| Product-Env-Stewards Product Envir              |  |                           | nviro Compliance         |              |   | NA                  |                  |                         |                    | Product-Env-Stewards@onsemi.com |                  |                  |           |  |
| Authorized Representative* Title - Representati |  |                           | entative                 |              | Phone - Representative*   |                     |                  | Email - Representative* |                    |                                 |                  |                  |           |  |
| Product-Env-Stewards Produc                     |  |                           | roduct Enviro Compliance |              |   | NA                  |                  |                         |                    | Product-Env-Stewards@onsemi.com |                  |                  |           |  |
| Requester Item Number                           | Mfr Item Number  |                           | Mfr Item Name            |              |   | Effective Date      | Version          | М                       | Manufacturing Site |                                 | Weight*          | UOM              | Unit Type |  |
|   | NB4N85   | B4N855SMR4G 3.3V DUAL TRA |                          | NSLATOR      |   | 2024-04-17          |                  | М                       | MY1                |                                 | 34.72            | mg               | Each      |  |
| Manufacturing Proccess Information              | on   |                           |                          |              |   |                     |                  |                         |                    |                                 |                  |                  |           |  |
| Terminal Plating / Grid Array Mate              | Terminal Plating / Grid Array Material Terminal Base All   |                           | Alloy J                  | -STD-020 MSI | L Rating  | Peak Proc           | ess Body Te      | mperature               | e Max Time at Peak | Tempera                         | ture Numb        | er of Reflow Cyc | eles      |  |
| Matte Tin (Sn) - annealed CU Alloy              |  | 1                         | 1                        |              | 260   |                     | С                | 30                      | seco               | nds 3                           |                  |                  |           |  |
| Comments  |  |                           |                          |              |   |                     |                  |                         |                    |                                 |                  |                  |           |  |
| evel 1 - maximum time at peak temperature       | e during sol   | dering is 10-3            | 0 seconds                |              |   |                     |                  |                         |                    |                                 |                  |                  |           |  |
| For more information regarding material co      | mposition  | please refer to           | page 3                   |              |   |                     |                  |                         |                    |                                 |                  |                  |           |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance                  | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|----------------------------|------------------|--------|---------|-----------------|
| Die                  | 0.31   | mg              | Supplier | Silicon (Si)               | 7440-21-3        |        | 0.31    | mg              |
| Die Attach           | 0.91   | mg              |          | Epoxy resin                | proprietary data |        | 0.0228  | mg              |
|                      |        |                 | Supplier | Silver (Ag)                | 7440-22-4        |        | 0.769   | mg              |
|                      |        |                 | Supplier | Phenolic Resin             | Proprietary Data |        | 0.0228  | mg              |
|                      |        |                 | Supplier | Inorganic filler           | Proprietary Data |        | 0.0228  | mg              |
|                      |        |                 | Supplier | Dicyandiamine              | 461-58-5         |        | 0.0046  | mg              |
|                      |        |                 | Supplier | Formaldehyde Polymer       | 9003-36-5        |        | 0.0682  | mg              |
| Lead Frame           | 17.82  | mg              | Supplier | Zinc (Zn)                  | 7440-66-6        |        | 0.0214  | mg              |
|                      |        |                 | Supplier | Iron (Fe)                  | 7439-89-6        |        | 0.4188  | mg              |
|                      |        |                 | Supplier | Copper (Cu)                | 7440-50-8        |        | 17.3745 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)             | 7723-14-0        |        | 0.0053  | mg              |
| Mold Compound-Black  | 14.88  | mg              |          | Epoxy resin                | proprietary data |        | 0.744   | mg              |
|                      |        |                 | Supplier | Phenolic Resin             | Proprietary Data |        | 0.744   | mg              |
|                      |        |                 | Supplier | Ortho Cresol Novolac Resin | 29690-82-2       |        | 0.2976  | mg              |
|                      |        |                 | Supplier | Carbon Black (C)           | 1333-86-4        |        | 0.0744  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)        | 60676-86-0       |        | 13.02   | mg              |
| Plating              | 0.48   | mg              | Supplier | Tin (Sn)                   | 7440-31-5        |        | 0.48    | mg              |
| Wire Bond - Au       | 0.32   | mg              | Supplier | Gold (Au)                  | 7440-57-5        |        | 0.32    | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).